

DALC112S1

Application Specific Discretes A.S.D.™

LOW CAPACITANCE DIODE ARRAY FOR ESD PROTECTION

MAIN APPLICATIONS

Where ESD protection for high speed datalines is required:

- LAN / WAN equipment
- Computer I/O
- Graphic video port
- Set top box I/O



ARRAY of 12 diodes configured by cells of 2 diodes, each cell being used to protect signal line from transient overvoltages by clamping action.

Its very low capacitance allows to protect fast signals with no distortion. It is particularly suited for the protection of graphic video ports.

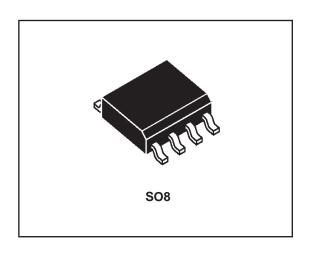
FEATURES

- ARRAYOF 12 DIODES FOR ESD PROTECTION.
- PEAK REVERSE VOLTAGE V_{RRM}= 18V PER DIODE.
- VERYLOW CAPACITANCE PER DIODE: C < 5pF.
- VERY LOW LEAKAGE CURRENT : $I_R < 2 \mu A$.

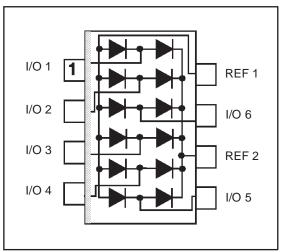
COMPLIES WITH THE FOLLOWING STANDARDS:

IEC 1000-4-2 level 3

8 kV (air discharge) 6 kV (contact discharge)



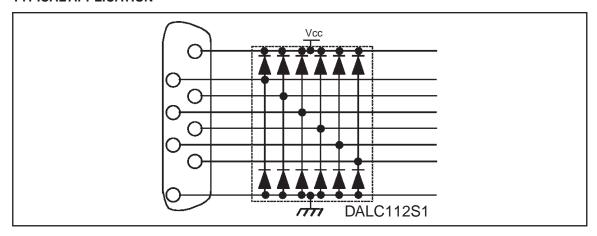
FUNCTIONAL DIAGRAM



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TYPICAL APPLICATION



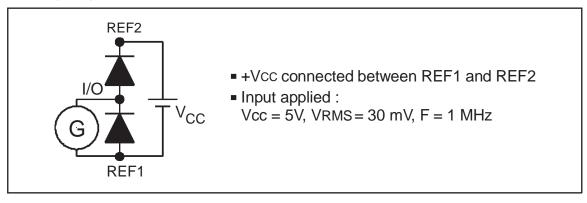
ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25$ °C).

Symbol	Parameter	Value	Unit	
V _{RRM}	Peak reverse voltage per diode	18	V	
T _{stg} T _j	Storage temperature range Maximum junction temperature	-55 to + 150 150	°C °C	

ELECTRICAL CHARACTERISTICS (Tamb = 25°C).

Symbol	Parameter			Max.	Unit
V _F	Forward voltage I _F = 5	0 mA		1.3	V
I _R	Reverse leakage current per diode V _R =	15 V		2	μΑ
С	Input capacitance between Line and GND $V_{cc} = 5 \text{ V}$, $V_{RMS} = 30 \text{ mV}$, $F = 1 \text{ MHz}$ (see figure 1 below)		7		pF

Fig 1: Input capacitance measurement



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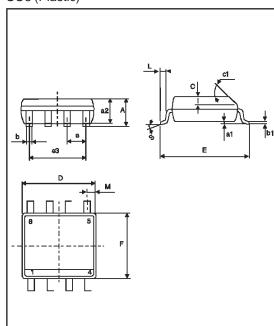
DALC 1 12 S 1 RL Diode Array Low Capacitance Nb. of Diodes DALC 1 12 S 1 RL RL = tape& reel (2500 pcs). = tube (100 pcs).

MARKING

Туре	Marking	Order Code	Packaging (Base Qty)
DALC112S1	DALC12	DALC112S1 DALC112S1RL	tube (100) tape & reel (2500)

PACKAGE MECHANICAL DATA

SO8 (Plastic)



REF.	DIMENSIONS					
	Millimetres		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
С		0.50			0.020	
с1	45° (typ)					
D	4.8		5.0	0.189		0.197
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
е3		3.81			0.150	
F	3.8		4.0	0.15		0.157
L	0.4		1.27	0.016		0.050
М			0.6			0.024
S	8° (max)					

PACKAGING: Preferred packaging is tape and reel.

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